Universal Hexadecimal Counter

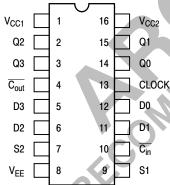
The MC10136 is a high speed synchronous counter that can count up, count down, preset, or stop count at frequencies exceeding 100 MHz. The flexibility of this device allows the designer to use one basic counter for most applications, and the synchronous count feature makes the MC10136 suitable for either computers or instrumentation.

Three control lines (S1, S2, and Carry In) determine the operation mode of the counter. Lines S1 and S2 determine one of four operations; preset (program), increment (count up), decrement (count down), or hold (stop count). Note that in the preset mode a clock pulse is necessary to load the counter, and the information present on the data inputs (D0, D1, D2, and D3) will be entered into the counter. Carry Out goes low on the terminal count, or when the counter is being preset.

This device is not designed for use with gated clocks. Control is via S1 and S2.

- $P_D = 625 \text{ mW typ/pkg (No Load)}$
- $f_{count} = 150 \text{ MHz typ}$
- $t_{pd} = 3.3 \text{ ns typ (C-Q)}$
- 7.0 ns typ (C-C_{out})
- 5.0 ns typ ($\overline{C_{in}}$ - C_{out})

DIP PIN ASSIGNMENT



Pin assignment is for Dual–in–Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

FUNCTION TABLE

C _{in}	S1	S2	Operating Mode
Х	L	L	Preset (Program)
٦	L	Н	Increment (Count Up)
Н	L	Н	Hold Count
L	Н	L	Decrement (Count Down)
Н	Н	L	Hold Count
Х	Н	Н	Hold (Stop Count)



ON Semiconductor

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MARKING DIAGRAMS



CDIP-16 L SUFFIX CASE 620





PDIP-16 P SUFFIX CASE 648





PLCC-20 FN SUFFIX CASE 775



A = Assembly Location

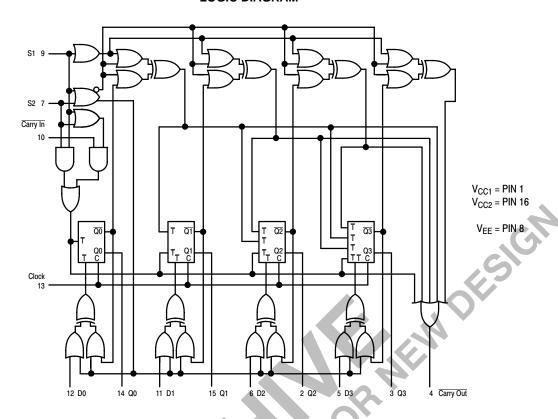
WL = Wafer Lot YY = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10136L	CDIP-16	25 Units / Rail
MC10136P	PDIP-16	25 Units / Rail
MC10136FN	PLCC-20	46 Units / Rail

LOGIC DIAGRAM



NOTE: Flip-flops will toggle when all $\overline{\mathsf{T}}$ inputs are low.

SEQUENTIAL TRUTH TABLE*

	INPUTS								(OUTP	JTS	
S1	S2	D0	D1	D2	D3	Carry In	Clock **	Q0	Q1	Q2	Q3	Carry Out
L	L	L	П	H	Н	X	Н	L	L	Н	Н	L
L	Н	X	X	X	X	L	Н	Н	L	Н	Н	Н
L	Н	X	X	X	X	L	Н	L	Н	Н	Н	Н
L	Н	Х	X	X	X	L	Н	Н	Н	Н	Н	L
L	Н	Χ	X	X	X	Н	L	Н	Н	Н	Н	Н
L	Н	Χ	X	X	Χ	Н	Н	Н	Н	Н	Н	Н
Н	Н	Χ	X	X	Χ	Χ	Н	Н	Н	Н	Н	Н
L	L	Н	H	L	L	Х	Н	Н	Н	L	L	L
Н	L	X	X	Χ	Χ	L	Н	L	Н	L	L	Н
Н	L	X	X	Χ	Χ	L	Н	Н	L	L	L	Н
Н	L	Х	Χ	Χ	Χ	L	Н	L	L	L	L	L
H		X	Χ	Χ	Χ	L	Н	Н	Н	Н	Н	Н

^{*} Truth table shows logic states assuming inputs vary in sequence shown from top to bottom.
* A clock H is defined as a clock input transition from a low to a high logic level.

ELECTRICAL CHARACTERISTICS

			Test Limits							
		Pin Under	-30)°C		+25°C		+85	5°C	1
Characteristic	Symbol	Test	Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply Drain Current	Ι _Ε	8		138		100	125		138	mAdc
Input Current	linH	5,6,11,12 7 9,10 13		350 425 390 460			220 265 245 290		220 265 245 290	μAdc
	I _{inL}	All	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	14 (2.)	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
Output Voltage Logic 0	V _{OL}	14 (2.)	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
Threshold Voltage Logic 1	V _{OHA}	14 (2.)	-1.080		-0.980			-0.910		Vdc
Threshold Voltage Logic 0	V _{OLA}	14 (2.)		-1.655			-1.630		-1.595	Vdc
Switching Times (50Ω Load) Propagation Delay Clock Input		14 14 4 4	0.8 0.8 2.0 2.0	4.8 4.8 10.9 10.9	1.0 1.0 2.5 2.5	3.3 3.3 7.0 7.0	4.5 4.5 10.5 10.5	1.4 1.4 2.4 2.4	5.0 5.0 11.5 11.5	ns
Carry In to Carry Ou	t ₁₀₋₄₋ t ₁₀₊₄₊	4 (3.) 4	1.6 1.6	7.4 7.4	1.6 1.6	5.0 5.0	6.9 6.9	1.9 1.9	7.5 7.5	
Setup Time Data Inputs	t ₁₂₊₁₃₊ t ₁₂₋₁₃₊	14 14	3.5 3.5		3.5 3.5			3.5 3.5		
Select Inputs	t ₉₊₁₃₊ t ₇₊₁₃₊	14 14	6.0 6.0		6.0 6.0			6.0 6.0		
Carry In Inpu	t _{10–13+} t ₁₀₊₁₃₊	14 14	2.5 1.5		2.5 1.5			3.0 1.5		
Hold Time Data Inputs	t ₁₃₊₁₂₊ t ₁₃₊₁₂₋	14 14	0		0 0			0 0		
Select Inputs	t ₁₃₊₉₊ t ₁₃₊₇₊	14 14	-1.0 -1.0	30.	-1.0 -1.0			-1.0 -1.0		
Carry In Inpu	t ₁₃₊₁₀₋ t ₁₃₊₁₀₊	14 14	0		0 0			0 0		
Counting Frequency	f _{countup}	14 14	125 125		125 125	150 150		125 125		MHz
Rise Time (20 to 80%)	t ₄₊ t ₁₄₊	4	0.9 0.9	3.3 3.3	1.1 1.1	2.0 2.0	3.3 3.3	1.1 1.1	3.5 3.5	ns
Fall Time (20 to 80%)	t ₄₋ t ₁₄₋	4 14	0.9 0.9	3.3 3.3	1.1 1.1	2.0 2.0	3.3 3.3	1.1 1.1	3.5 3.5	

^{1.} Individually test each input; apply V_{ILmin} to pin under test.

Measure output after clock pulse V_{IL} V_{IH} appears at clock input (Pin 13).

Before test set all Q outputs to a logic high.
 To preserve reliable performance, the MC10136 (plastic packaged device only) is to be operated in ambient temperatures above 70°C only when 500lfpm blown air or equivalent heat sinking is provided.

ELECTRICAL CHARACTERISTICS (continued)

					TEST VOLTAGE VALUES (Volts)				
		@ Test Te	mperature	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
			–30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
			Pin	TEST V	OLTAGE AP	PLIED TO P	INS LISTED	BELOW	٠
Characteri	stic	Symbol	Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	(V _{CC}) Gnd
Power Supply Drain	Current	Ι _Ε	8					8	1, 16
Input Current		I _{inH}	5,6,11,12	5,6,11,12				8	1, 16
			7 9,10	7 9,10				8 8	1, 16 1, 16
			13	13				8	1, 16
		I _{inL}	All		Note 1.			8	1, 16
Output Voltage	Logic 1	V _{OH}	14 (2.)	12	7, 9			8	1, 16
Output Voltage	Logic 0	V _{OL}	14 (2.)		7, 9			8	1, 16
Threshold Voltage	Logic 1	V _{OHA}	14 (2.)		7, 9	12		8	1, 16
Threshold Voltage	Logic 0	V_{OLA}	14 (2.)		7, 9		12	8	1, 16
Switching Times	(50 Ω Load)			+1.11V	+0.31V	Pulse In	Pulse Out	−3.2 V	+2.0 V
Propagation Delay	Clock Input	t ₁₃₊₁₄₊	14	12		13	14	8	1, 16
		t ₁₃₊₁₄₋ t ₁₃₊₄₊	14 4	7		13 13	14 4	8 8	1, 16 1, 16
		t ₁₃₊₄₊	4	7		13	4	8	1, 16
Carry Ir	n to Carry Out	t ₁₀₋₄₋	4 (3.)	7	13 13	10	4	8	1, 16
		t ₁₀₊₄₊	4	7		10	4	8	1, 16
Setup Time	Data Inputs	t ₁₂₊₁₃₊ t _{12–13+}	14 14		7, 9 7, 9	12, 13 12, 13	14 14	8 8	1, 16 1, 16
	Select Inputs		14		7, 3	9, 13	14	8	1, 16
	Ocioci inputs	t ₉₊₁₃₊ t ₇₊₁₃₊	14			7, 13	14	8	1, 16
7	Carry In Inputs	t ₁₀₋₁₃₊	14	7	9	10, 13	14	8	1, 16
		t ₁₀₊₁₃₊	14	7	9	10, 13	14	8	1, 16
Hold Time	Data Inputs	t ₁₃₊₁₂₊	14		7, 9	12, 13	14	8	1, 16
	0-1	t ₁₃₊₁₂ -	14		7, 9	12, 13	14	8	1, 16
	Select Inputs	t ₁₃₊₉₊ t ₁₃₊₇₊	14 14			9, 13 7, 13	14 14	8 8	1, 16 1, 16
<u> </u>	Carry In Inputs	t ₁₃₊₁₀ -	14	7	9	10, 13	14	8	1, 16
	,	t ₁₃₊₁₀₊	14	7	_	10, 13	14	8	1, 16
Counting Frequency		fcountup	14	7		13	14	8	1, 16
		f _{countdown}	14	9		13	14	8	1, 16
Rise Time	(20 to 80%)	t ₄₊ t ₁₄₊	4 14	7 7		13 13	4 14	8 8	1, 16 1, 16
Fall Time	(20 to 80%)		4	7		13	4	8	1, 16
i all fillie	(20100070)	t ₄₋ t ₁₄₋	14	7		13	14	8	1, 16
Individually tost on				·		L .ö			1, 10

^{1.} Individually test each input; apply V_{ILmin} to pin under test.

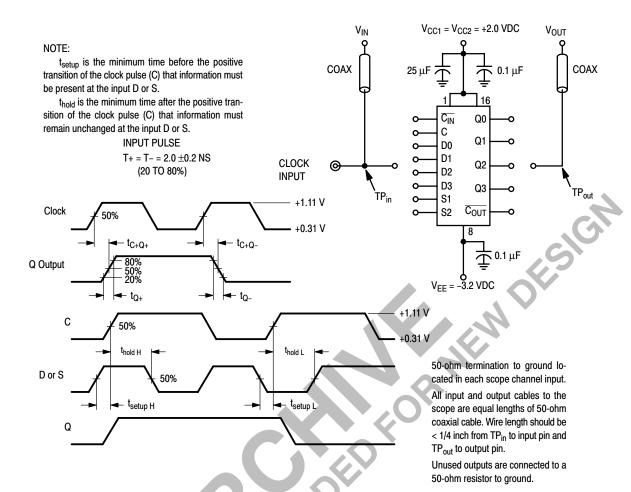
Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibitum has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to –2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

^{2.} Measure output after clock pulse V_{IL} VIH appears at clock input (Pin 13).

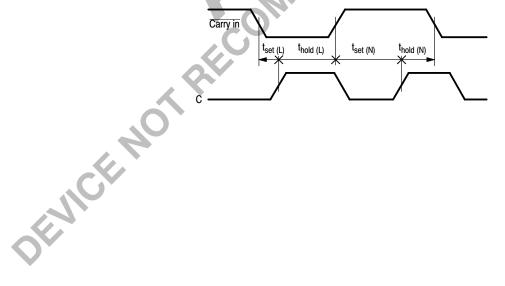
^{3.} Before test set all Q outputs to a logic high.

^{4.} To preserve reliable performance, the MC10136 (plastic packaged device only) is to be operated in ambient temperatures above 70°C only when 500lfpm blown air or equivalent heat sinking is provided.

SWITCHING TIME TEST CIRCUIT AND WAVEFORMS @ 25°C



CARRY IN SET UP AND HOLD TIMES



APPLICATIONS INFORMATION

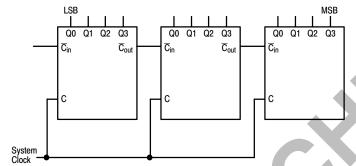
To provide more than four bits of counting capability several MC10136 counters may be cascaded. The Carry In input overrides the clock when the counter is either in the increment mode or the decrement mode of operation. This input allows several devices to be cascaded in a fully synchronous multistage counter as illustrated in Figure 1. The carry is advanced between stages as shown with no external gating. The Carry In of the first device may be left open. The system clock is common to all devices.

The various operational modes of the counter make it useful for a wide variety of applications. If used with MECL III devices, prescalers with input toggle frequencies in excess of 300 MHz are possible. Figure 2 shows such a prescaler using the MC10136 and MC1670. Use of the MC10231 in place of the MC1670 permits 200 MHz operation.

The MC10136 may also be used as a programmable counter. The configuration of Figure 3 requires no additional gates, although maximum frequency is limited to about 50 MHz. The divider modulus is equal to the program input plus one (M=N+1), therefore, the counter will divide by a modulus varying from 1 to 16.

A second programmable configuration is also illustrated in Figure 4. A pulse swallowing technique is used to speed the counter operation up to 110 MHz typically. The divider modulus for this figure is equal to the program input (M = N). The minimum modulus is 2 because of the pulse swallowing technique, and the modulus may vary from 2 to 15. This programmable configuration requires an additional gate, such as $^{1}/_{2}MC10109$ and a flip-flop such as $^{1}/_{2}MC10131$.

Figure 1. 12 BIT SYNCHRONOUS COUNTER



NOTE: S1 and S2 are set either for increment or decrement operation.

Figure 2. 300 MHz PRESCALER

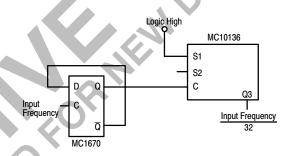
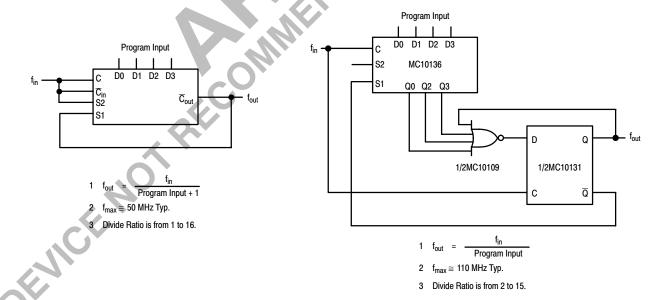


Figure 3. 50 MHz PROGRAMMABLE COUNTER

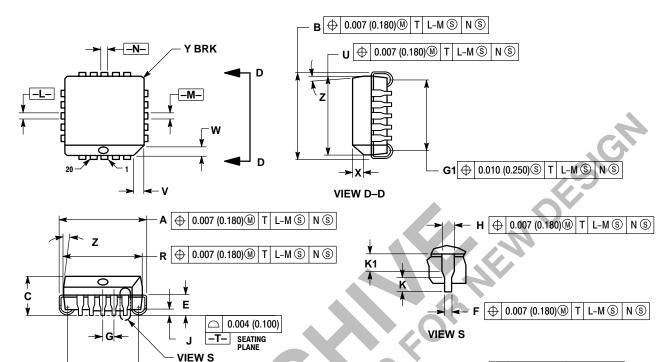
Figure 4. 100 MHz PROGRAMMABLE COUNTER



PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



NOTES:

G1 ⊕ 0.010 (0.250)③ T L-M ⑤ N ⑤

OF MICE. NOT PERSON

- IOTES:

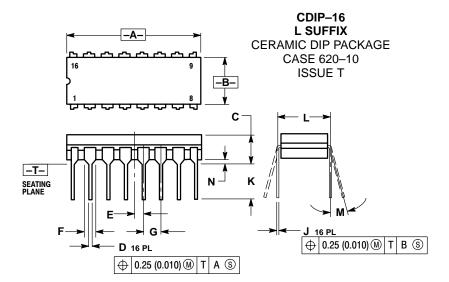
 1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIM	ETERS	
DIM	MIN MAX		MIN	MAX	
Α	0.385	0.395	9.78	10.03	
В	0.385	0.395	9.78	10.03	
C	0.165	0.180	4.20	4.57	
Е	0.090	0.110	2.29	2.79	
F	0.013	0.019	0.33	0.48	
G	0.050	BSC	1.27	BSC	
Н	0.026	0.032	0.66	0.81	
J	0.020		0.51		
K	0.025		0.64		
R	0.350	0.356	8.89	9.04	
U	0.350	0.356	8.89	9.04	
٧	0.042	0.048	1.07	1.21	
W	0.042	0.048	1.07	1.21	
Х	0.042	0.056	1.07	1.42	
Υ		0.020		0.50	
Z	2°	10°	2 °	10 °	
G1	0.310	0.330	7.88	8.38	
K1	0.040		1.02		



NOTES:

- ANIES.

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

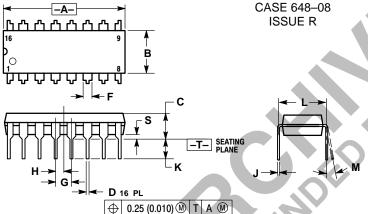
 CONTROLLING DIMENSION: INCH.

 DIMENSION L TO CENTER OF LEAD WHEN

- FORMED PARALLEL.
 DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC

	INC	HES	MILLIN	IETERS	
DIM	MIN MAX		MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62 BSC		
M	0 °	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIM	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	

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